

## 2.5~5.5V输入，2A同步降压变换器

### 2.5~5.5V Input, 2A, Synchronous Buck Converter

#### ■ FEATURES

- 2A converter with 150mΩ and 100mΩ FETs
- Input voltage range: 2.5V~5.5V
- Output voltage range: 0.6 V~VIN
- Power save mode to keep high efficiency in light load
- 100% duty cycle for low dropout
- 30uA Quiescent Current
- 1.5MHz typical switching frequency
- Shutdown current:  $\leq 1 \mu\text{A}$  (typical)
- Soft start and start delay
- Over current limit protection
- Power good output
- Non-latching Undervoltage protection and Thermal Shutdown protection
- Enable pin
- Packages: Pb-free Packages, SOT23-6
- 2A降压，内置150mΩ和100mΩ功率管
- 输入电压范围：2.5V~5.5V
- 输出电压范围：0.6V~VIN
- 轻载下具有节能高效率
- 支持100%占空比低压降
- 30uA静态电流
- 1.5MHz典型开关频率
- 关断电流 $\leq 1 \mu\text{A}$  (典型值)
- 软起动，启动延迟
- 过流检测限制保护
- PG输出
- 欠压保护、过热关断保护，不锁定可自动恢复
- 具有使能pin
- 无铅封装，SOT23-6

#### ■ APPLICATIONS

- 5V power rail applications
- Set top box
- Consumer electronics
- Industrial power supplies
- 5V电源轨
- 机顶盒
- 消费电子
- 工业电子

### DESCRIPTION

The HT7702 is a 2A, synchronous buck converter with minimum external components and low shutdown current.

The device operates in PWM mode with typical 1.5MHz switching frequency at medium to heavy loads. At light load, the device operates in power save mode to keep high efficiency.

The output voltage is adjustable through external resistor.

The HT7702 is available in SOT23-6 packages.

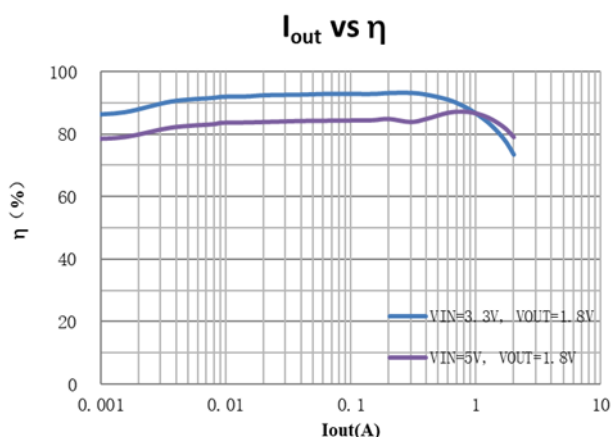
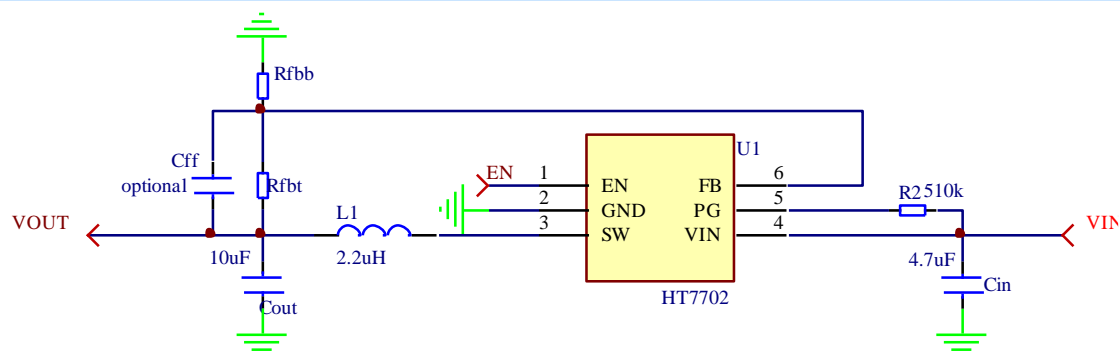
HT7702 是一款 2A同步降压转换器，具有最少的外部元件和低关断电流。

该器件在中到重载时，工作在典型开关频率为1.5MHz的PWM模式；在轻载时，器件工作在高效节能模式。

输出电压可通过外部电阻调节。

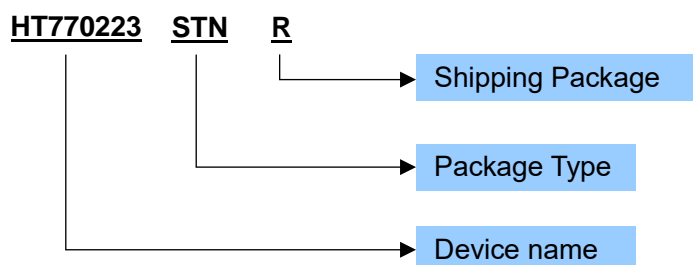
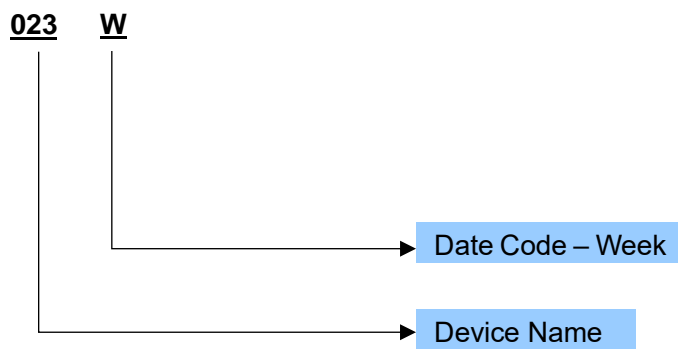
HT7702 采用SOT23-6封装。

### TYPICAL APPLICATION

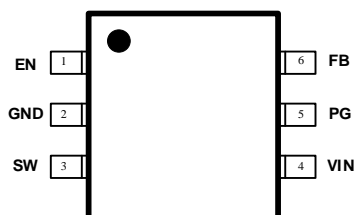


**ORDERING INFORMATION**

Part Number	Package Type	Marking	Operating Temperature Range	Shipping Package / MOQ
HT770223STNR	SOT23-6 (STN)	023W	-40℃～85℃	Tape and Reel / TBD

**Part Number**

**Marking**


## ■ TERMINAL CONFIGURATION



Top View

## ■ TERMINAL FUNCTION

Terminal No.	Name	Description
1	EN	Enable input. Pull EN below the specified threshold to shut down the device. Pull EN above the specified threshold to enable the device. Don't leave EN floating. EN can be connected to VIN. 使能脚。将EN拉到阈值以下以关闭。将EN拉至阈值以上启用。EN脚不能悬空，可以接到VIN脚。EN脚接分压电阻到VIN。
2	GND	Ground. GND should be placed as close to the output capacitor as possible to avoid the high-current switch paths. 地。GND应尽可能靠近输出电容，以避免高电流开关路径。
3	SW	Switch node. 开关端口。
4	VIN	Input supply. VIN supplies power to all of the internal control circuitries. A decoupling capacitor to ground must be placed close to VIN to minimize switching spikes. 输入电源。VIN为所有内部控制电路供电。接地滤波电容必须放置在VIN附近，以减少开关尖峰。
5	PG	Power good pin. Open drain output. The pull-up resistor should not be connected to any voltage higher than 5.5V. Leave it floating if not used. 开漏输出。外部上拉电阻到电源不能超过5.5V；若不使用，则悬空。
6	FB	Feedback. Connect resistor divider to output voltage. 反馈。接分压电阻到输出电压。

## ■ SPECIFICATIONS<sup>1</sup>

### ● Absolute Maximum Ratings<sup>2</sup>

PARAMETER	Symbol	MIN	TYP	MAX	UNIT
VIN, EN, PG voltage	VIN	-0.3		6	V
FB voltage	FB	-0.3		5.5	V
SW voltage (DC)	SW	-2		VIN+0.3	V
SW voltage (10ns transient)	SW	-3.5		9	V
Moisture Sensitivity Level (MSL)			MSL3		
Junction Temperature	TJ	-40		150	°C
Storage Temperature	TSTG	-55		150	°C
ESD, Human-body model (HBM)	HBM		±2000		V
ESD, Charged-device model (CDM)	CDM		±500		V

### ● Recommended Operating Conditions

PARAMETER	Symbol	CONDITION	MIN	TYP	MAX	UNIT
VIN supply voltage	VIN		2.5		5.5	V
Output voltage	VOUT		0.6		VIN	V
Output current	IOUT		0		2	A
Operation Temperature	TA		-40		85	°C

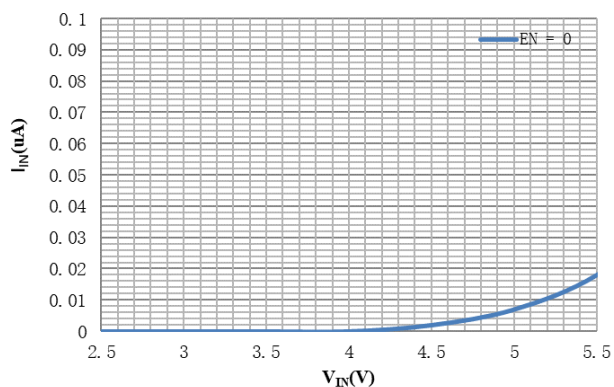
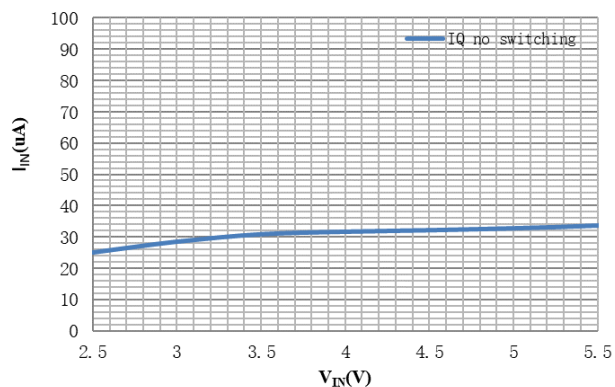
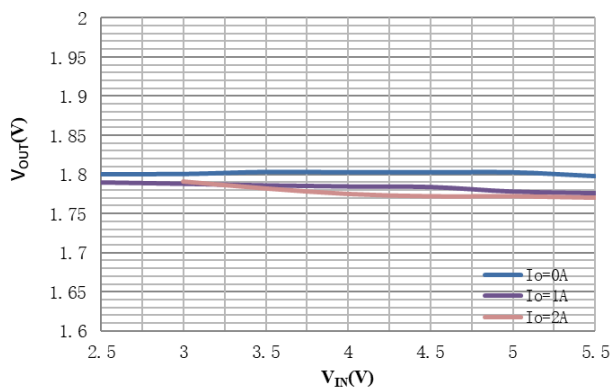
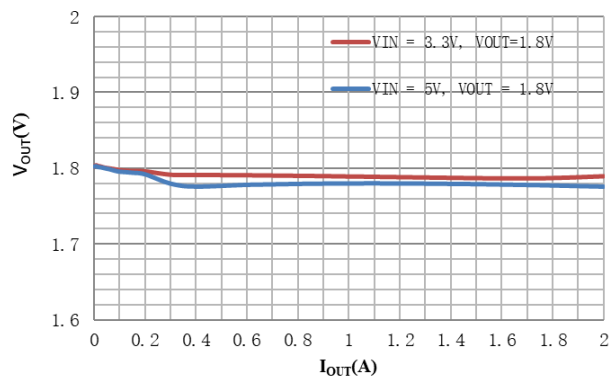
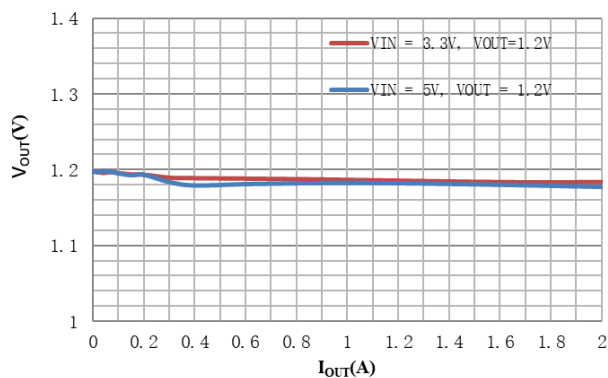
### ● Electrical Characteristics

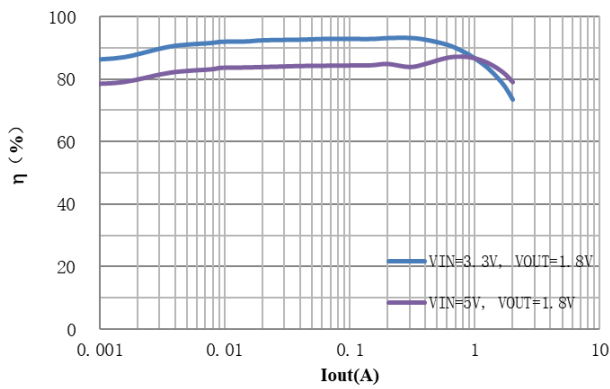
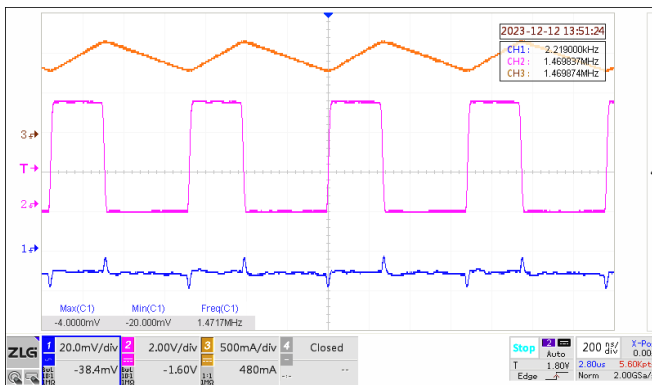
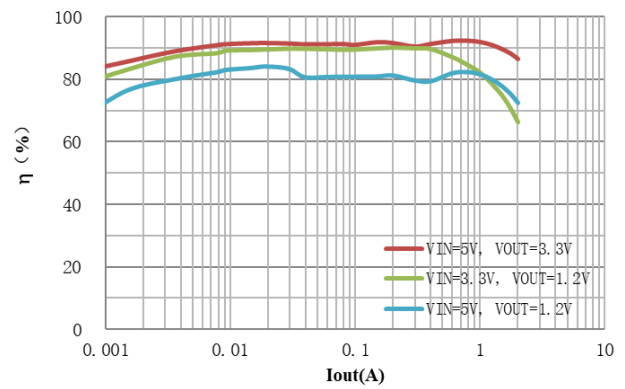
VIN = 5V, TA = +25°C, unless otherwise noted.

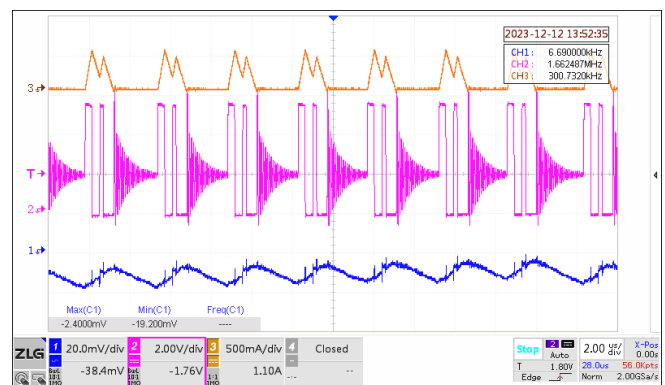
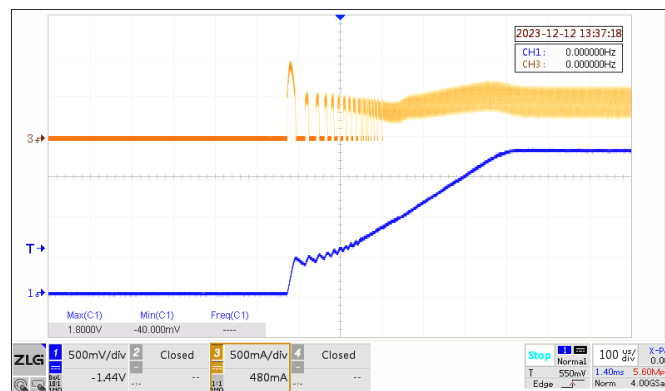
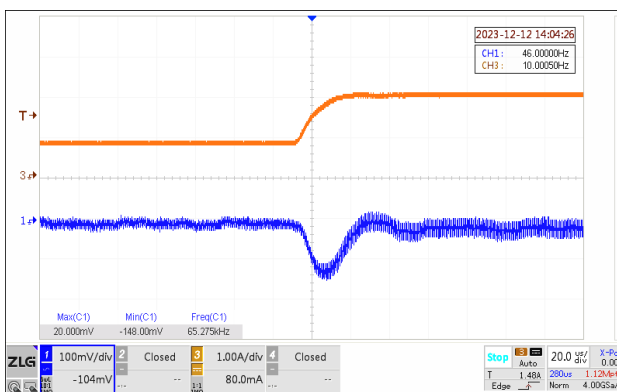
PARAMETER	Symbol	CONDITION	MIN	TYP	MAX	UNIT
VIN UVLO threshold	VUVLO	Rising		2.40		V
		Falling		2.30		V
VIN UVLO hysteresis	Vhys			0.06		V
Quiescent supply current	IQ	EN=H, VFB = 1.0 V, no switching		30		uA
Shutdown supply current	ISD	VEN = 0V		0.005		μA
High-side switch on resistance	RDS(ON)_H	VBST - VSW = 5.5V		150		mΩ
Low-side switch on resistance	RDS(ON)_L			100		mΩ
Current limit (high-side switch)	ILIM			3		A
Zero cross current detection	IzC			0		A
EN up threshold	VENH			1.1	1.3	V
EN low threshold	VENL		0.4	0.95		V
Power good threshold	VPG	VFB rising, referenced to VFB nominal		88%		
		VFB falling, referenced to VFB nominal		70%		
Power good low-level output voltage	VPG_OL	SINK = 1 mA			0.4	V
Input leakage current into PG pin	IPG	VPG = 5V		0.01		uA
Power good delay	tPG_Delay	VFB falling		40		us
Feedback voltage	VFBH			600		mV
Soft-start time	tSS			800		us
Switching frequency	fsw	VOUT = 1.8V		1.5		MHz
Thermal shutdown		Trigger thermal shutdown		150		°C
		Hysteresis		20		°C

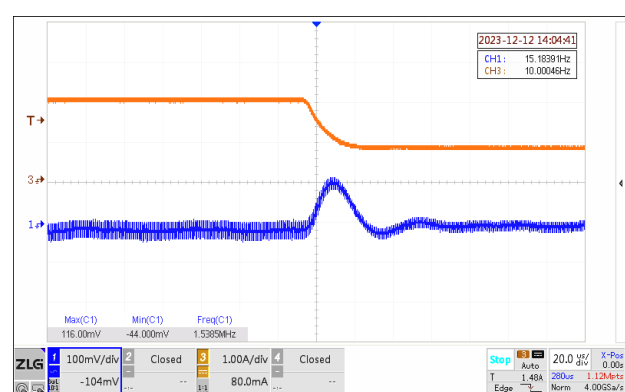
<sup>1</sup> Depending on parts and PCB layout, characteristics may be changed.

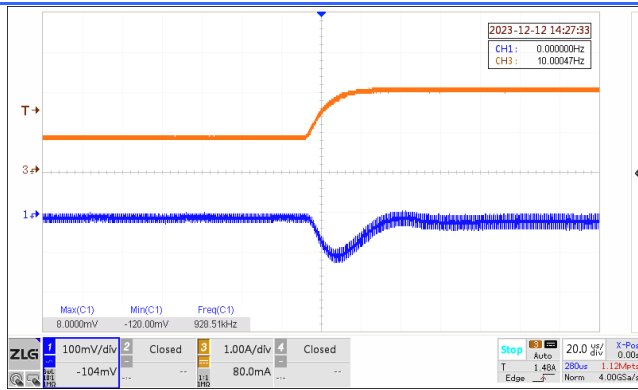
<sup>2</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**TYPICAL OPERATING CHARACTERISTICS**
 **$V_{IN}$  vs  $I_{IN}$** 

 **$V_{IN}$  vs  $I_{IN}$** 

 **$V_{IN}$  vs  $V_{OUT}$** 

 **$I_{OUT}$  vs  $V_{OUT}$** 

 **$I_{OUT}$  vs  $V_{OUT}$** 


$I_{out}$  vs  $\eta$ 

 $I_{out}$  vs  $\eta$ 

 $V_{IN} = 5V, V_{OUT} = 1.8V, I_{LOAD} = 1A$ 

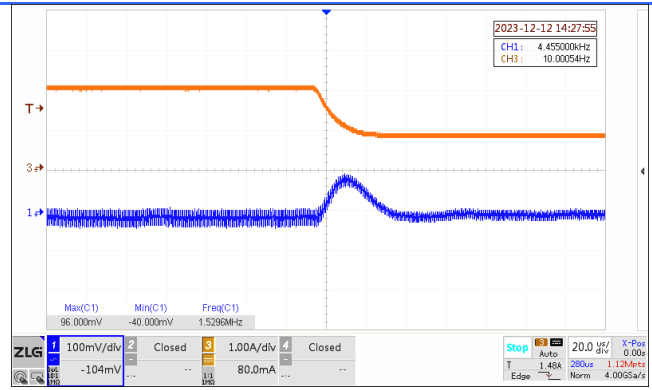
 CH1-> $V_{OUT}$ ; CH2-> $V_{sw}$ , CH3-> $I_{sw}$ 

 $V_{IN} = 5V, V_{OUT} = 1.8V, I_{LOAD} = 0.1A$ 

 $I_{Load} = 4R$ , Startup Sequence, CH1-> $V_{OUT}$ , CH3-> $I_{sw}$ 

 $V_{IN} = 5V, V_{OUT} = 1.8V, I_{LOAD} = 0.8A \rightarrow 2A$ 

 CH1-> $V_{OUT}$ ; CH3-> $I_{out}$ 

 $V_{IN} = 5V, V_{OUT} = 1.8V, I_{LOAD} = 2A \rightarrow 0.8A$



$V_{IN} = 5V$ ,  $V_{OUT} = 1.8V$ ,  $I_{LOAD} = 0.8A \rightarrow 2A$ ,  $C_{FF} = 22pF$

CH1  $\rightarrow$   $V_{OUT}$ ; CH3  $\rightarrow$   $I_{OUT}$



$V_{IN} = 5V$ ,  $V_{OUT} = 1.8V$ ,  $I_{LOAD} = 2A \rightarrow 0.8A$ ,  $C_{FF} = 22pF$

## ■ APPLICATION INFORMATION

### 1 Description

The HT7702 is a 2A, synchronous buck converter with minimum external components and low shutdown current.

The device operates in PWM mode with typical 1.5MHz switching frequency at medium to heavy loads. At light load, the device operates in power save mode to keep high efficiency.

#### 1.1 Power Save Mode

At light load, the device operates in power save mode, the switching frequency and current is reduced.

#### 1.2 100% Duty Cycle for Low Dropout

The device offers an output voltage close to the input voltage as it supports 100% duty cycle, where the high-side switch FET is constantly turned on and the low-side switch FET is turned off.

### 2 Enable (EN) Control

The HT7702 has a dedicated enable control pin (EN) with positive logic. Its falling threshold is 0.4V, and its rising threshold is 1.3V.

When EN is below the threshold, the device is in shutdown mode where the switching regulator turns off.

### 3 Soft Start and Start Delay with Pre-biased Output Voltage

The HT7702 employs an internal 500us soft start to ramp up the FB voltage from 0V to 0.6V linearly once EN pulled high.

### 4 Under-Voltage Lockout (UVLO)

Under-voltage lockout (UVLO) is implemented to protect the chip from operating at an insufficient supply voltage. The UVLO rising threshold is about 2.36V, while its falling threshold is about 2.3V.

### 5 Thermal Shutdown

Thermal shutdown is implemented to prevent the chip from operating at exceedingly high temperatures. When the silicon die temperature is higher than its upper threshold, the entire chip shuts down. When the temperature is lower than its lower threshold, the chip is enabled again.

### 6 Over Current Limit Protection

The device is protected from over current by current limitation the peak of the inductor current. The high side power MOSFET current is accurately sensed via a current sense MOSFET. When the high-side MOSFET current reaches to the limitation, the high-side MOSFET is turned off and the low-side MOSFET is turned on to ramp down the inductor current with an adaptive off-time.

HT7702 是一款 2A 同步降压转换器，具有最少的外部元件和低关断电流。

该器件在中到重载时，工作在典型开关频率为 1.5MHz 的 PWM 模式；在轻载时，器件工作在高效节能模式。

在轻载时，器件工作在高效节能模式，频率降低，电流减小。

HT7702 是一款 2A 同步降压转换器，具有最少的外部元件和低关断电流。

该器件在中到重载时，工作在典型开关频率为 1.5MHz 的 PWM 模式；在轻载时，器件工作在高效节能模式。

HT7702 的 EN 脚高电平有效，控制芯片使能。其下降阈值为 0.4V，上升阈值为 1.3V。当 EN 低于 0.4V，器件进入关断模式。

HT7702 采用内部 500ums 软启动，一旦 EN 拉高，FB 电压就会线性上升至 0.6V。

欠压锁定 (UVLO) 功能可避免芯片工作在电源电压不足的条件。UVLO 上升阈值约为 2.36V，下降阈值为 2.3V。

过热关断保护是为了防止芯片在极高的温度下工作。当芯片温度高于其上限阈值时，整个芯片关闭。当温度低于其下限阈值时，芯片再次启用。

该器件通过对电感电流峰值的电流限制来防止过流。高侧功率管的电流被实时监测。当高侧功率管达到限流值，高侧功率管关断，低侧功率管在一个自适应的时间内导通，释放电感电流。

## 7 Setting the Output Voltage

The output voltage ( $V_{OUT}$ ) is set by a resistor divider ( $R_{FBT}$  and  $R_{FBB}$ ). The resistors can be determined with following Equation.

Where  $V_{FB}$  is 0.6V, typically.

输出电压 ( $V_{OUT}$ ) 由电阻分压器 ( $R_{FBT}$  和  $R_{FBB}$ ) 设置。电阻可以通过以下公式确定。

其中,  $V_{FB}=0.6V$ 。

$$V_{OUT} = V_{FB} \times \left(1 + \frac{R_{FBT}}{R_{FBB}}\right) \quad (2)$$

## 8 Selecting the Inductor and Output Capacitor

Use the inductor and output capacitor as following.

推荐电感和输出电容如下表。

OUTPUT VOLTAGE (V)	$R_{FBT}$ (k $\Omega$ )	$R_{FBB}$ (k $\Omega$ )	$C_{FF}$ (pF) (optional)	L (uH)			$C_{OUT}$ (uF)
				MIN	TYP	MAX	
1.2	100	100	22	1	2.2	2.2	22~44
1.5	150	100	22	1	2.2	2.2	22~44
1.8	200	100	22	1	2.2	2.2	10~44
2.5	150	47	22	1	2.2	2.2	10~44
3.3	120	26.7	22	1	2.2	2.2	10~44

The inductor peak-to-peak ripple current  $I_{L\_PP}$ , peak current  $I_{L\_PK}$  and RMS current  $I_{L\_RMS}$  are calculated as following. The inductor saturation current rating must be greater than the  $I_{L\_PK}$  and the RMS or heating current rating must be greater than  $I_{L\_RMS}$ .

电感峰峰值电流  $I_{L\_PP}$ 、峰值电流  $I_{L\_PK}$  和 RMS 电流  $I_{L\_RMS}$  计算如下。电感额定饱和电流必须大于  $I_{L\_PK}$ , RMS 或热电流额定值必须大于  $I_{L\_RMS}$ 。

$$I_{L\_PP} = \frac{V_{OUT}}{V_{IN\_MAX}} \times \frac{V_{IN\_MAX} - V_{OUT}}{L \times f_{SW}} \quad (3)$$

$$I_{L\_PK} = I_{OUT} + \frac{I_{L\_PP}}{2} \quad (4)$$

$$I_{L\_RMS} = \sqrt{I_{OUT}^2 + \frac{1}{12} \times I_{L\_PP}^2} \quad (5)$$

The output capacitor should be used with ceramic or other low ESR capacitors. The required RMS current rating for the output capacitor is as follow.

输出电容应使用陶瓷电容或其他低 ESR 电容。输出电容要求的额定 RMS 电流如下。

$$I_{C\_RMS} = \frac{(V_{IN\_MAX} - V_{OUT}) \times V_{OUT}}{\sqrt{12} \times F_{SW} \times V_{IN\_MAX} \times L} \quad (6)$$

## 9 Power Good (PG terminal)

The PG terminal is an open drain output, it can deliver device condition information as the following table with different PG status. Leave it float if not used.

PG 脚是一个开漏输出，其通过输出不同状态传达芯片状态信息，如下表。不使用时，可悬空。

Device condition		PG status	
		High Z	Low
Enable	VFB>VPG	√	
	VFB<VPG		√
Shutdown	EN = L		√
Thermal Shutdown			√
Under-Voltage Lockout			√
Power Removal	VIN < 0.7V	√	

## 10 Input Capacitor (C<sub>IN</sub>)

An input decoupling capacitor (0.1uF) and a bulk capacitor (Over 10uF) is needed. The voltage rating should be higher than the maximum input voltage.

输入端推荐一个滤波电容（0.1uF）和一个储能电容（超过 10uF）。额定电压应高于最大输入电压。

## 11 PCB Layout Guidelines

Efficient PCB layout is critical for stable operation. For best results, refer to following figure and follow the guidelines below.

(1) Place the input capacitor and output capacitor as close to the device as possible.

(2) Keep the power traces very short and fairly wide, especially for the SW node.

This can help greatly reduce voltage spikes on the SW node and lower the EMI noise level.

(3) Run the feedback trace as far from the inductor and noisy power traces (like the SW node) as possible.

有效的 PCB 布局对于稳定运行至关重要。要获得最佳结果，请参考下图并遵循以下指南。

（1）将输入电容、输出电容尽可能靠近芯片。

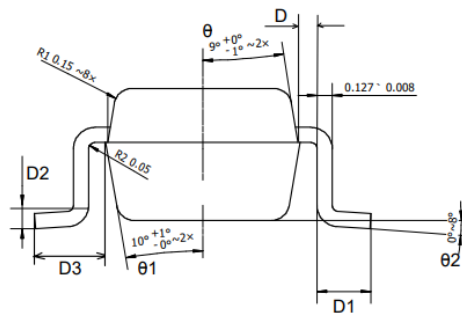
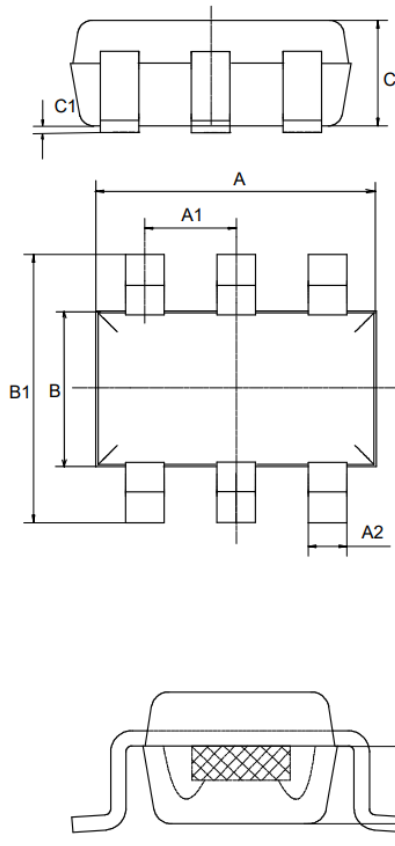
（2）保持电源轨迹非常短且相当宽，特别是对于 SW 节点。

这有助于大大降低 SW 节点上的电压尖峰，并降低 EMI 噪声水平。

（3）FB 走线尽可能远离电感和功率走线（如 SW 节点）。

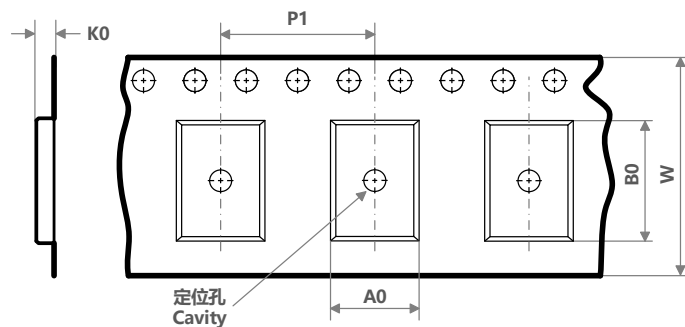
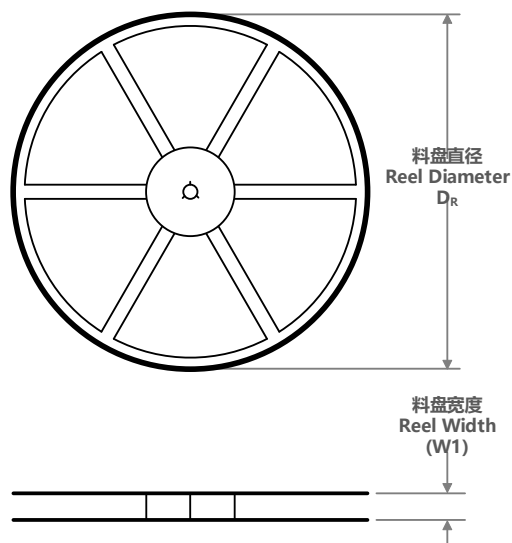
# ■ PACKAGE OUTLINE

## SOT23-6



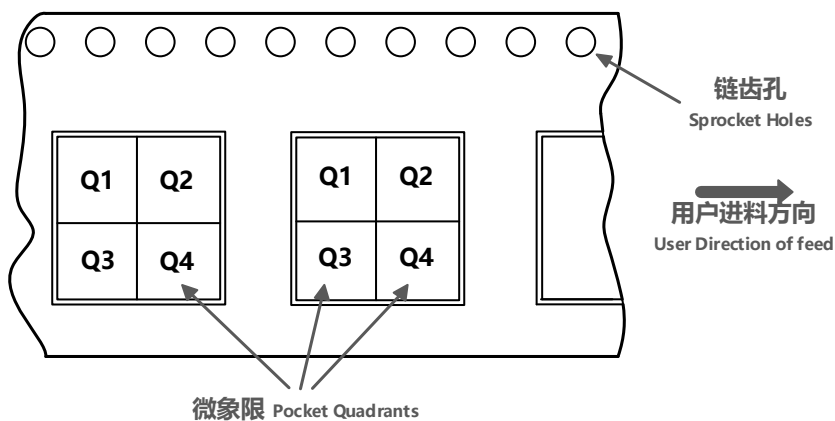
COMMON DIMENSIONS UNITS: MEASURE=MILLIMETER			
SYMBOL	MIN	NOM	MAX
A	2.82	2.92	3.02
A1	0.90	0.95	1.0
A2	0.30	0.35	0.40
B	1.52	1.62	1.72
B1	2.80	2.90	3.0
B2	0.12	0.128	0.135
C	1.05	1.10	1.15
C1	0.03	0.08	0.13
C2	0.6	0.65	0.7
D	0.03	0.08	0.13
D1	0.4	0.45	0.5
D2	0.25TYP		
D3	0.6	0.65	0.7

# TAPE AND REEL INFORMATION

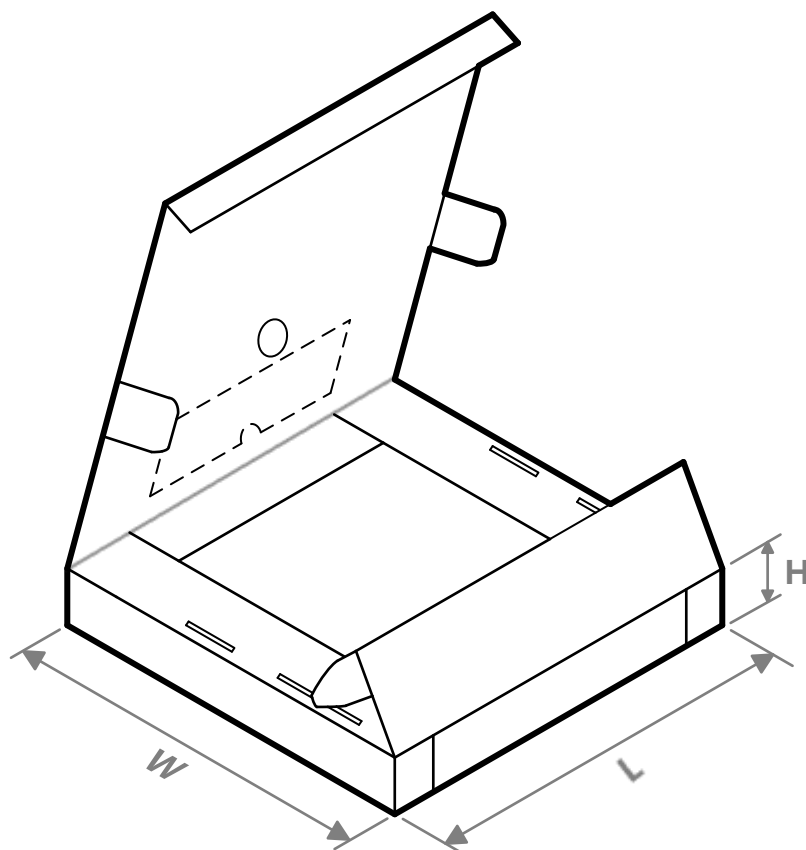


<b>A0</b>	Dimension designed to accommodate the component width; 料槽宽度
<b>B0</b>	Dimension designed to accommodate the component length; 料槽长度
<b>K0</b>	Dimension designed to accommodate the component thickness; 料槽厚度
<b>W</b>	Overall width of the carrier tape; 载带整体宽度
<b>P1</b>	Pitch between successive cavity centers; 相邻槽中心间距

## 编带 PIN1 方位象限分配 Quadrant Assignments for Pin1 Orientation in Tape



器件料号 Part No.	封装 类型 Package Type	封装 标识 Package Code	引脚 数 Pins	SPQ	料盘 直径 $D_R$ (mm)	料盘 宽度 $W1$ (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 象限 Quadrant
HT770223STNR	<b>SOT23</b>	STN	6	3000	178	9	3.2	3.18	1.38	4	8	Q3

**TAPE AND REEL BOX INFORMATION**


器件料号 Part No.	封装类型 Package Type	封装标识 Package Code	引脚数 Pins	SPQ	长度 Length (mm)	宽度 Width (mm)	高度 Height (mm)
HT770223STNR	SOT23	STN	6	45000	360	345	50
HT770223STNR	SOT23	STN	6	30000	360	345	50

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